

FIG. 1

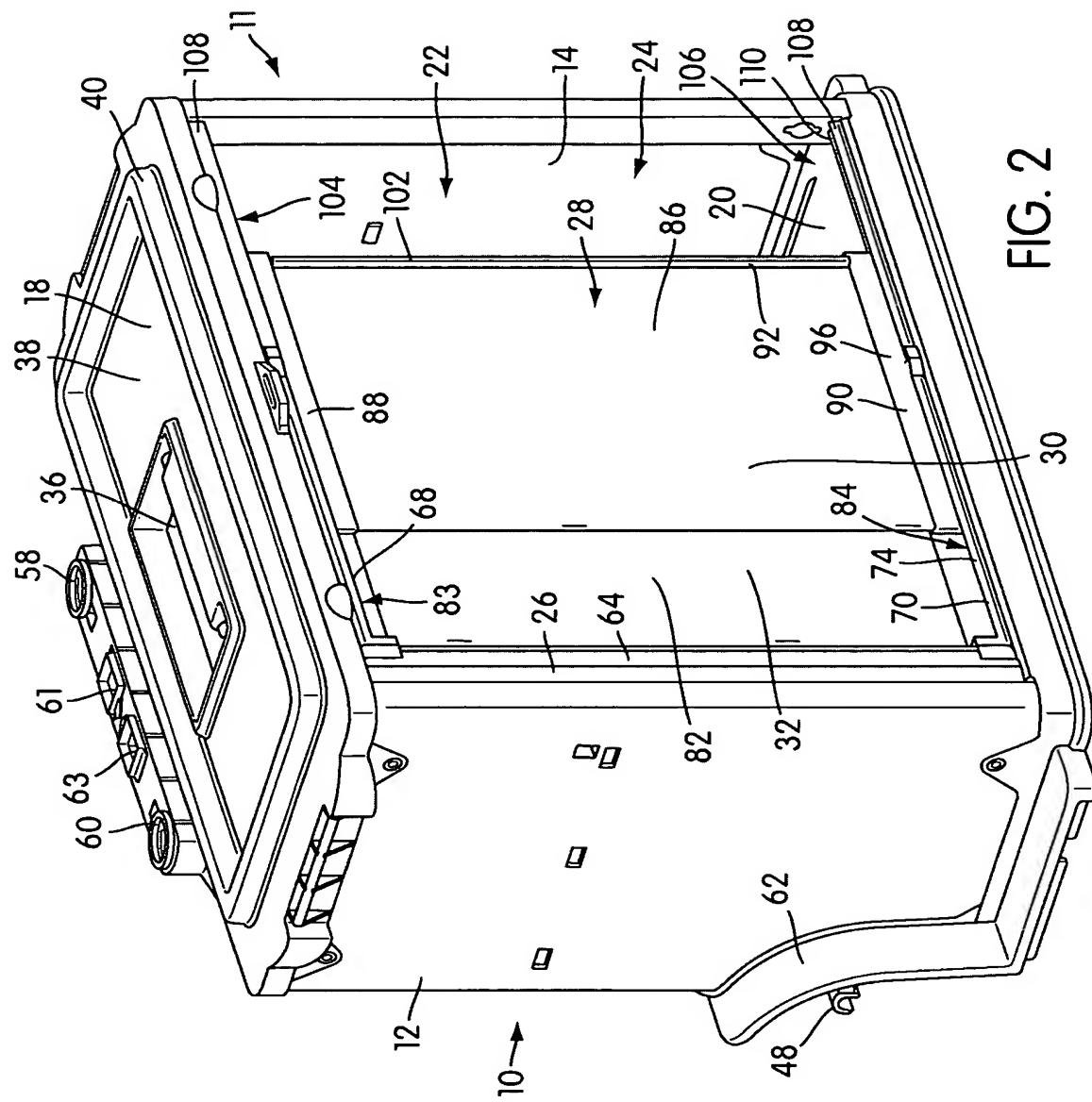
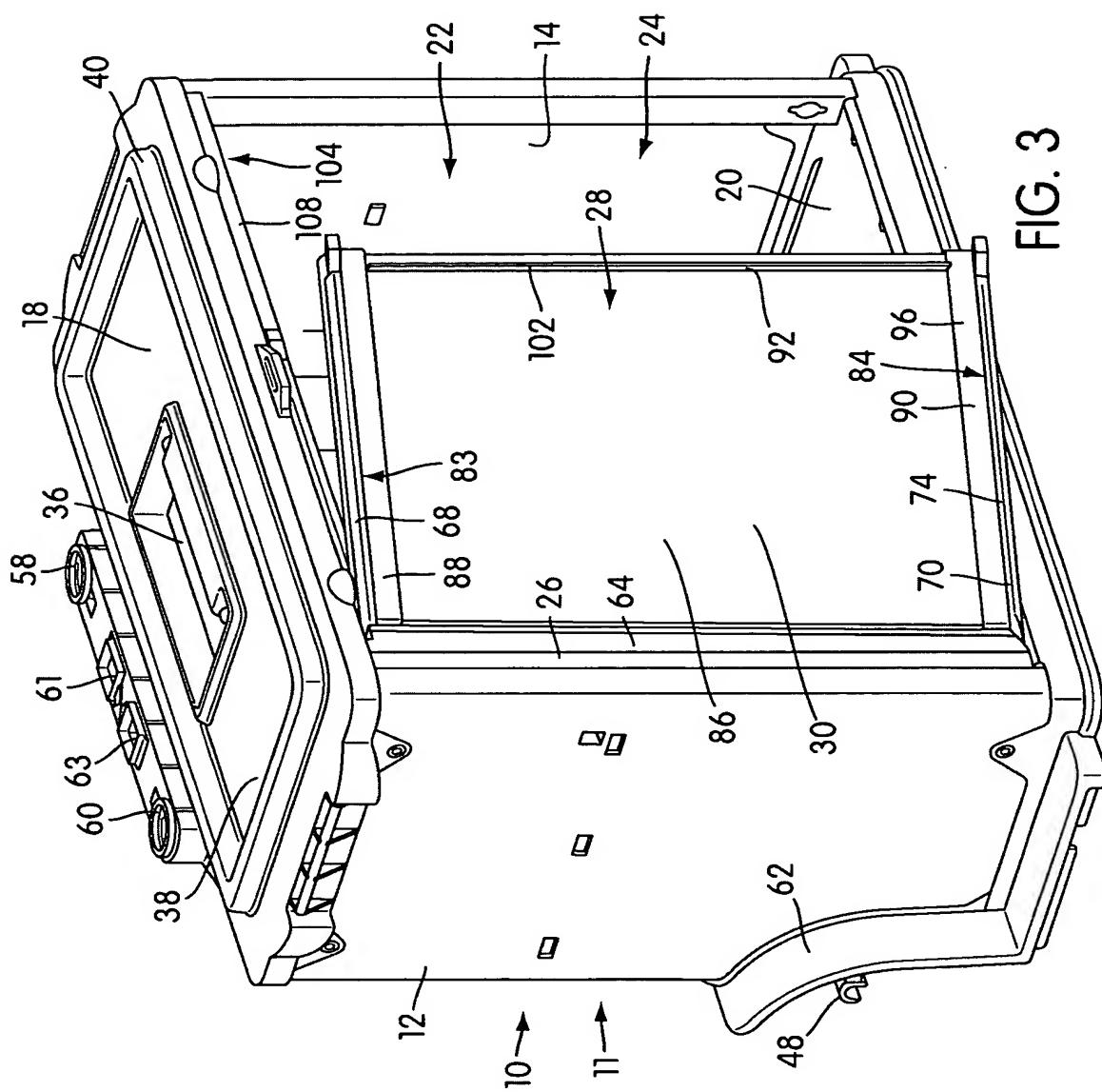


FIG. 2



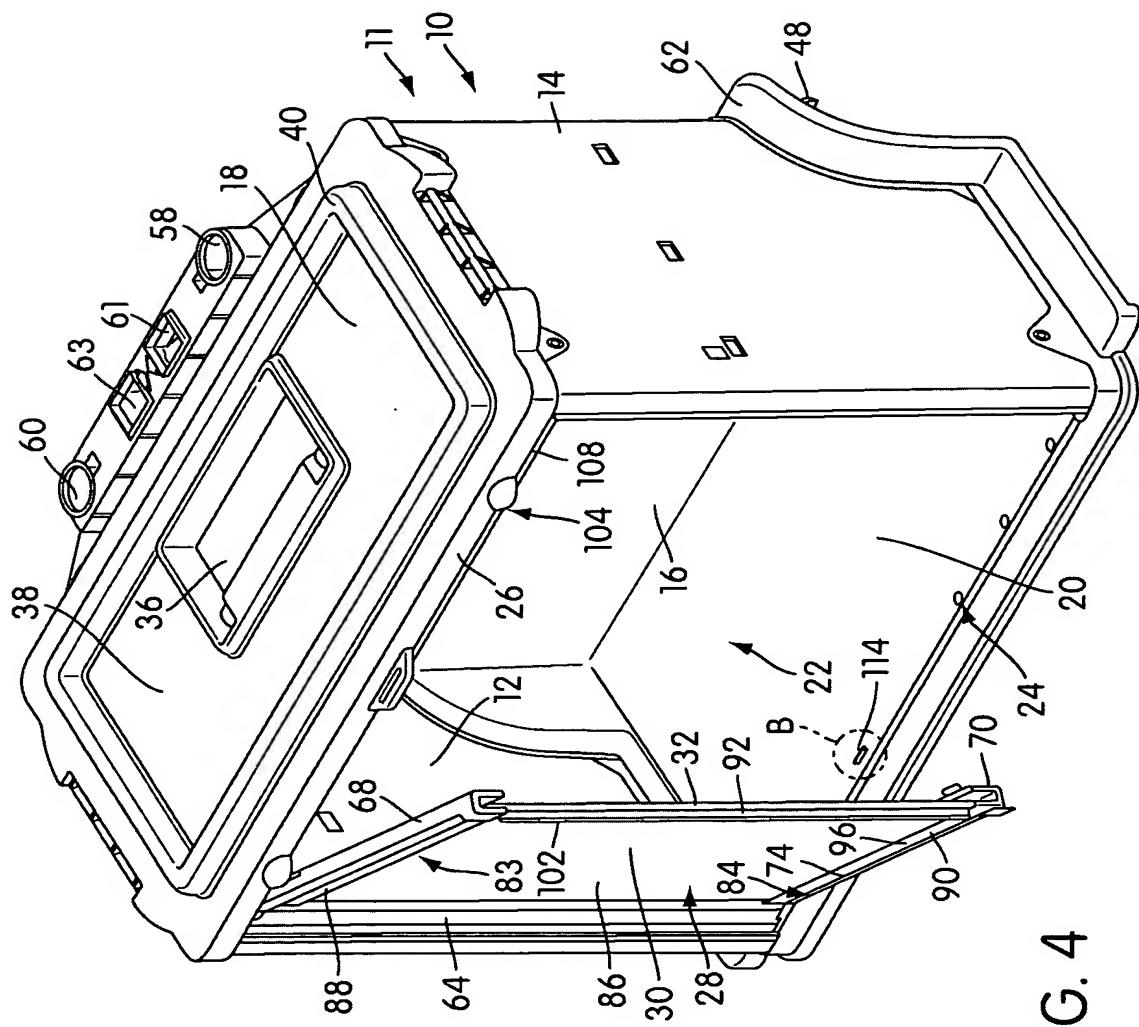


FIG. 4

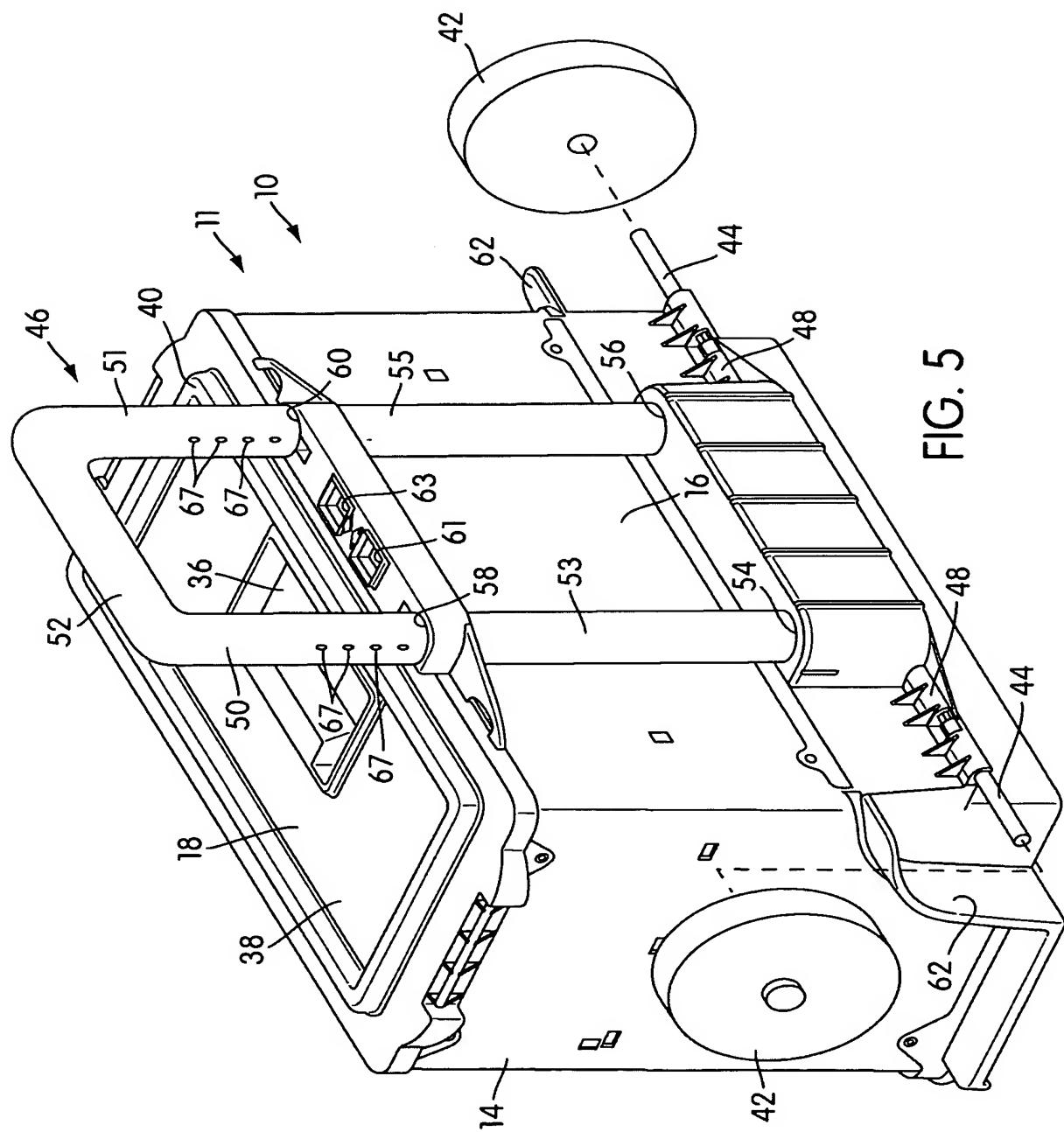


FIG. 6

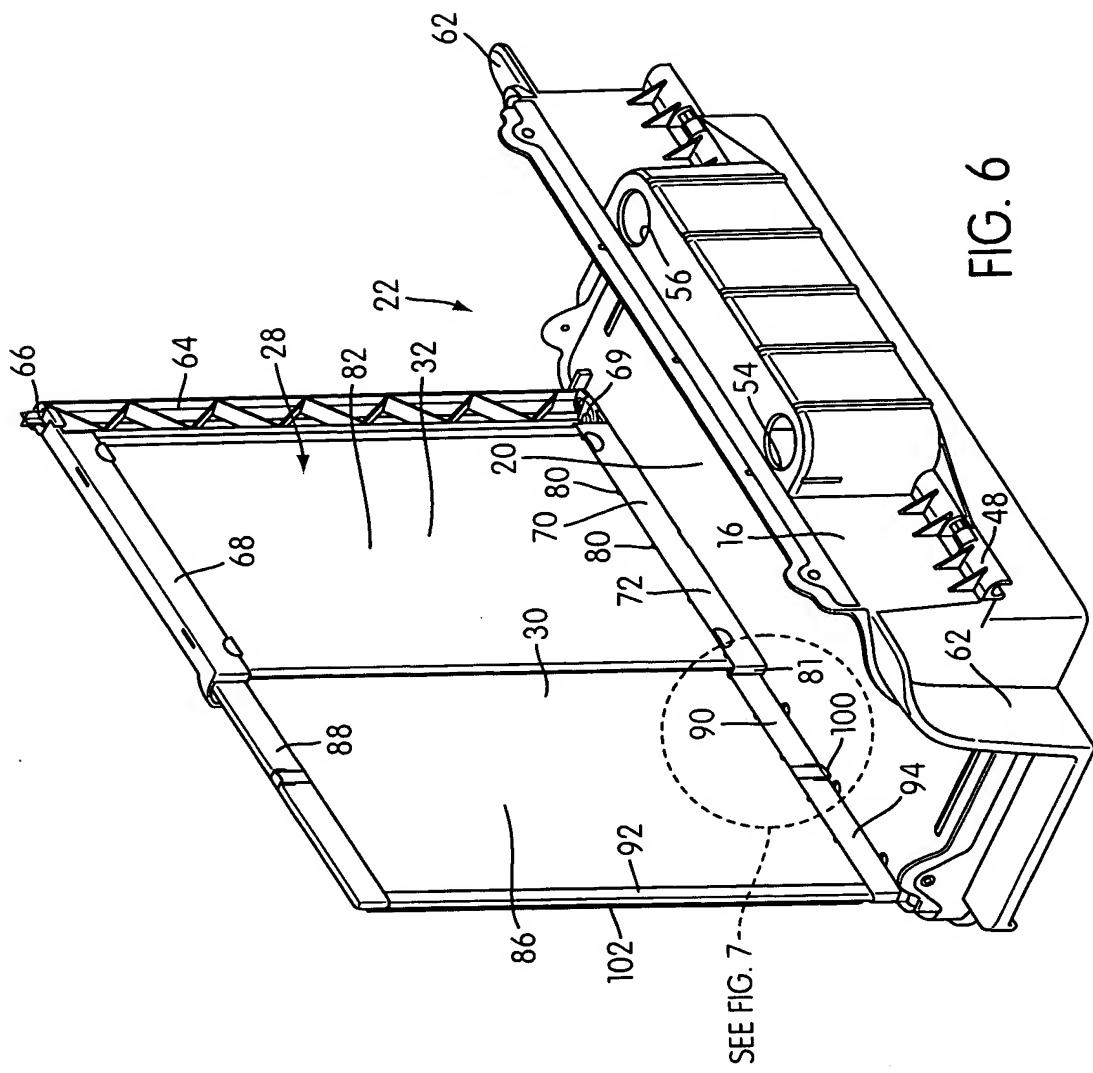


FIG. 7

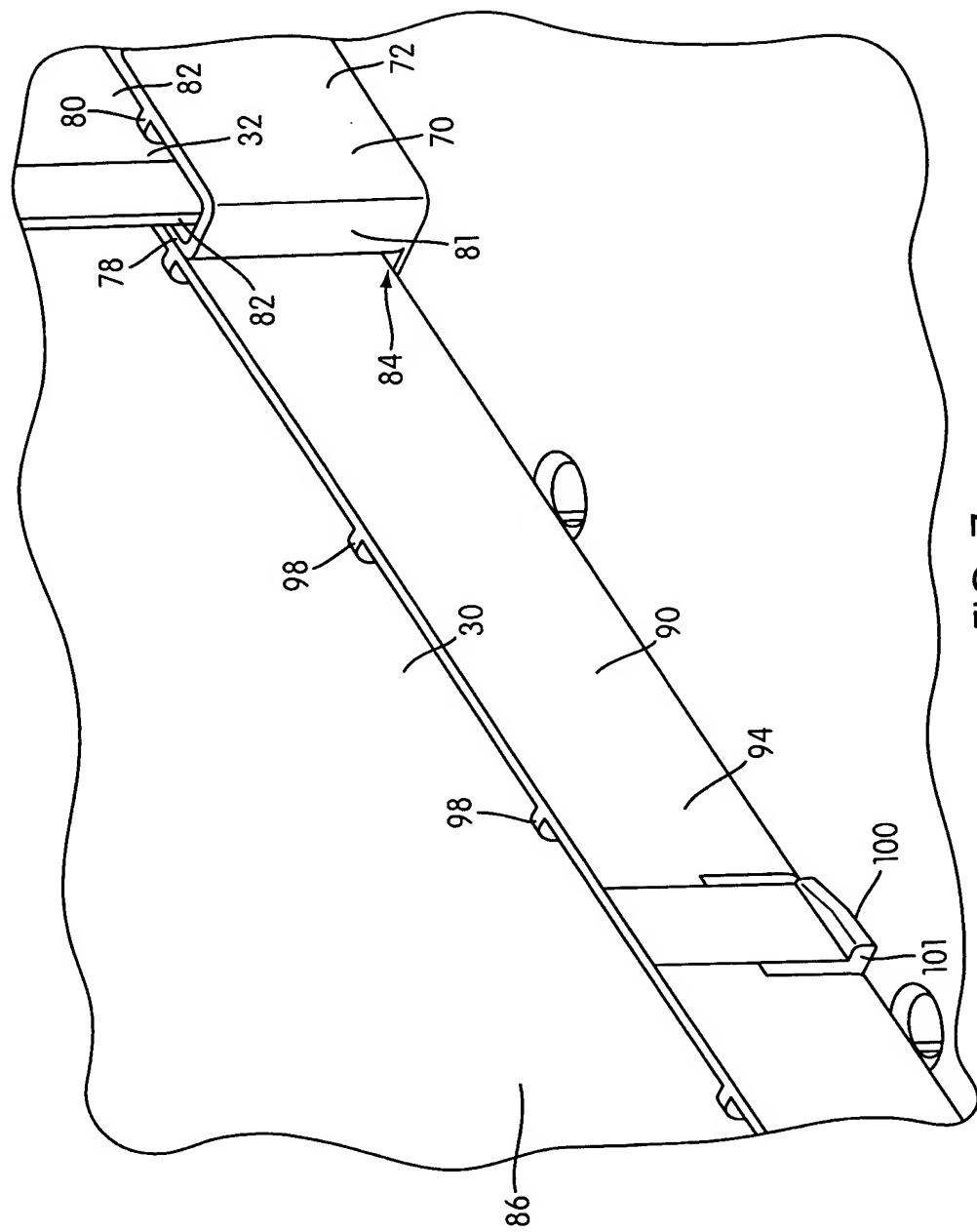
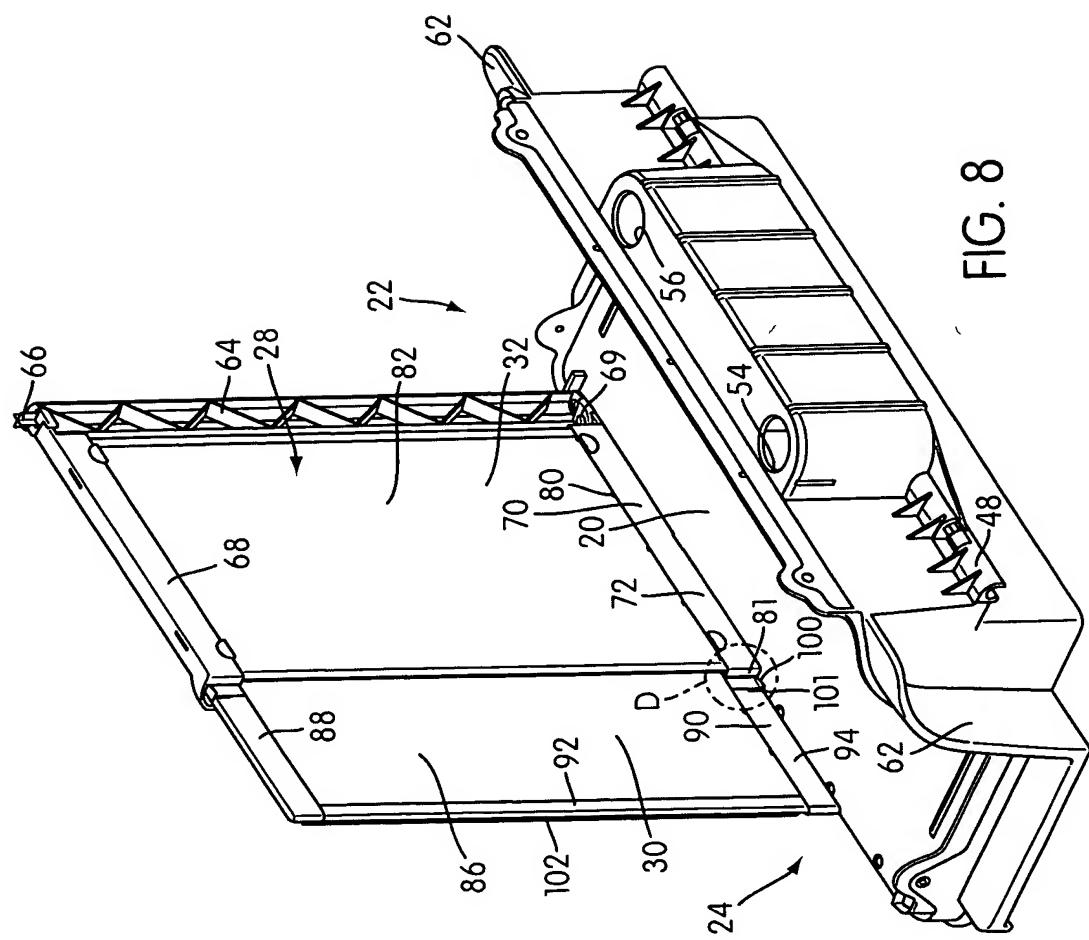
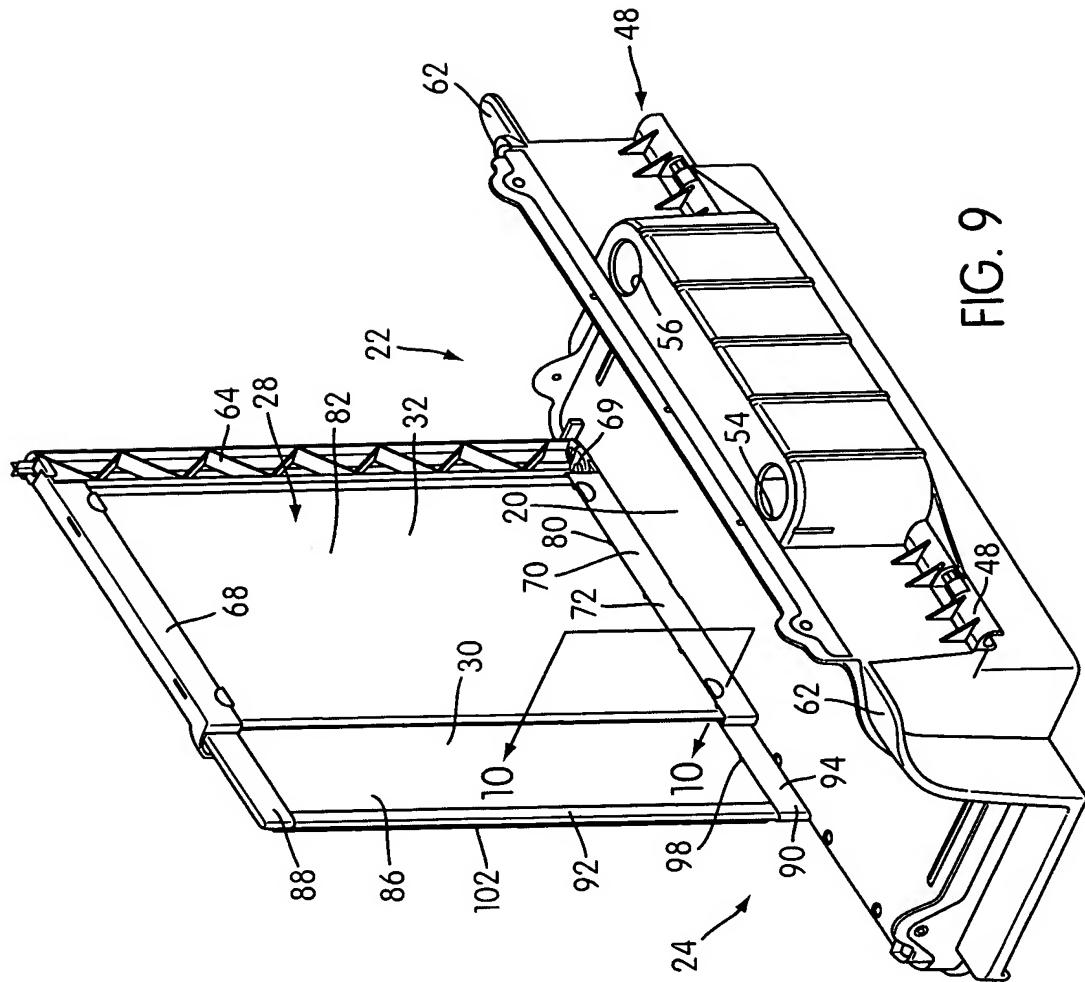


FIG. 8



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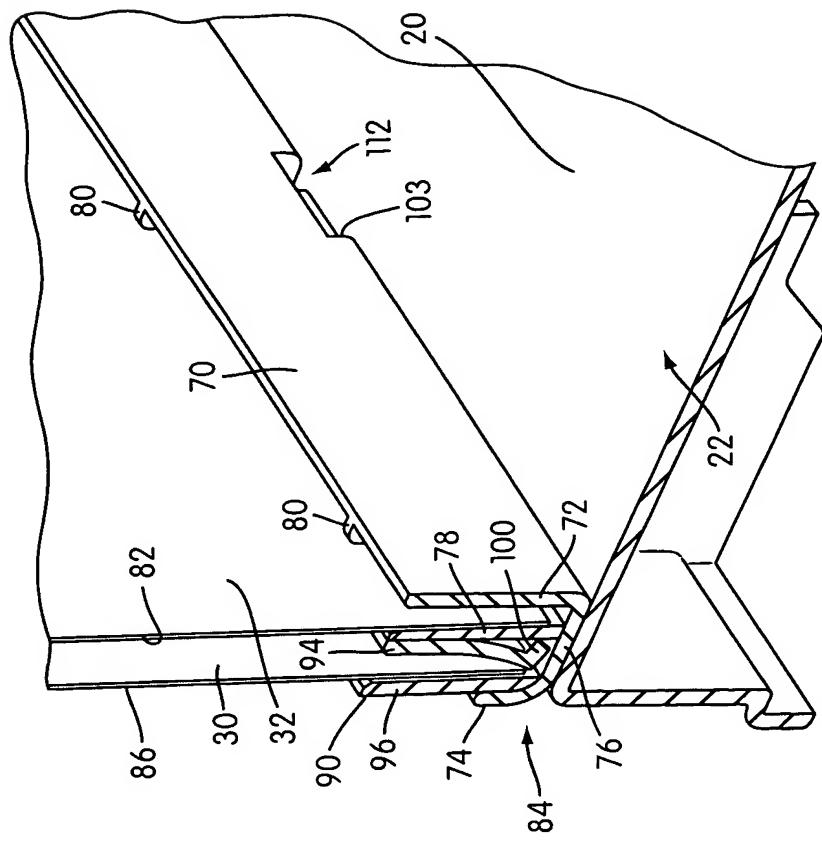
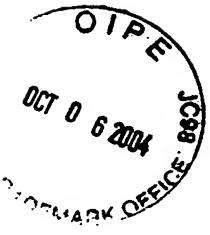
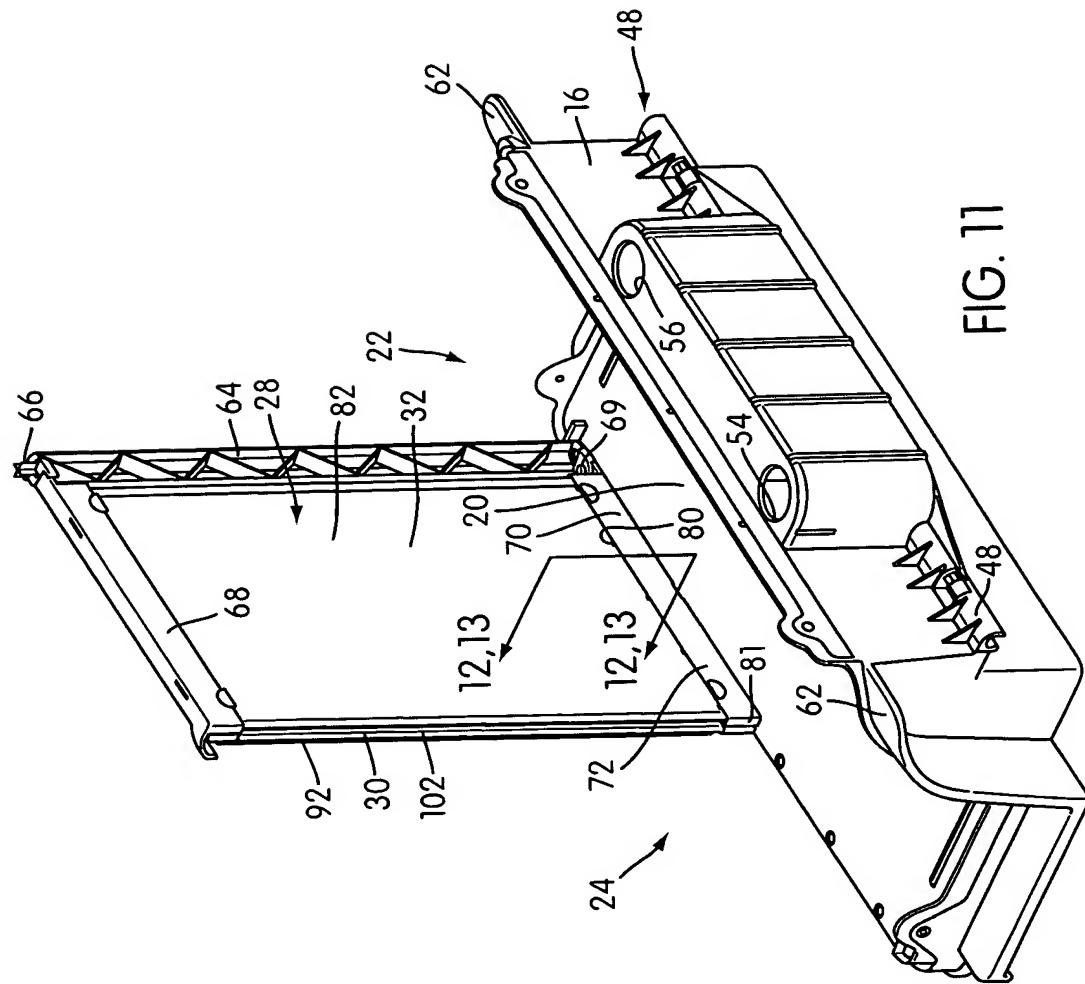


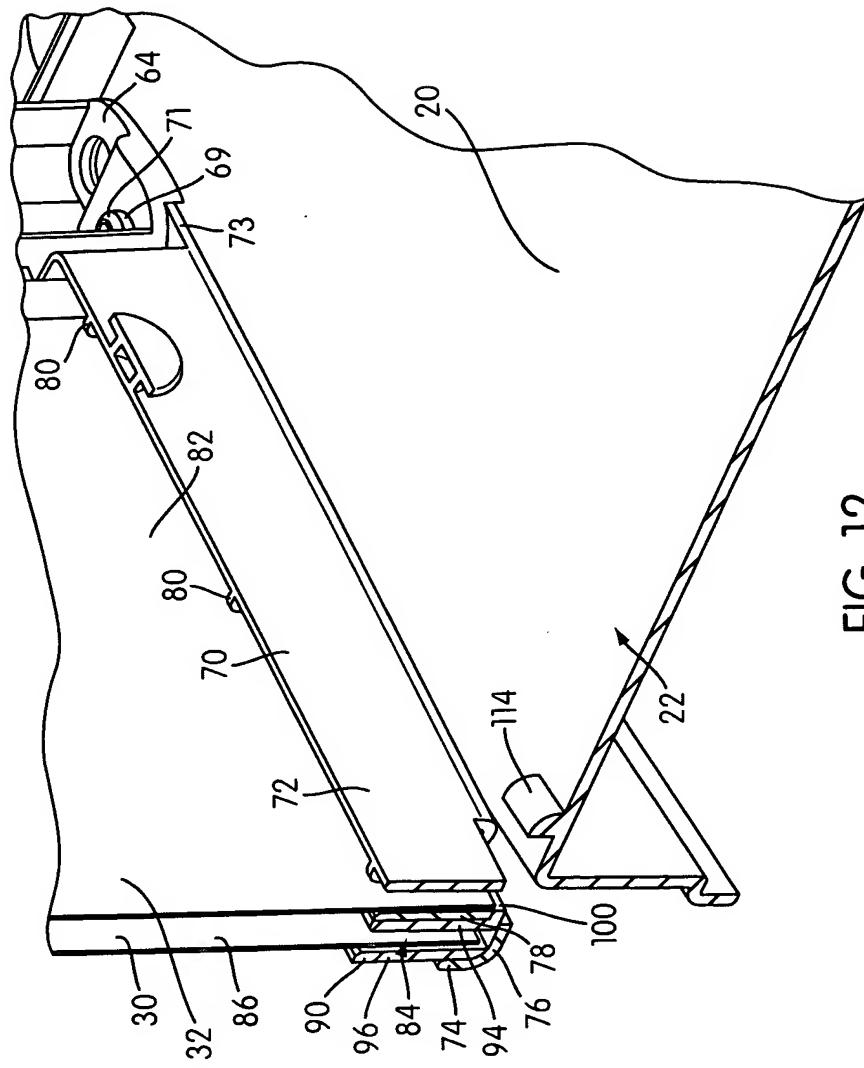
FIG. 10

FIG. 11



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FIG. 12



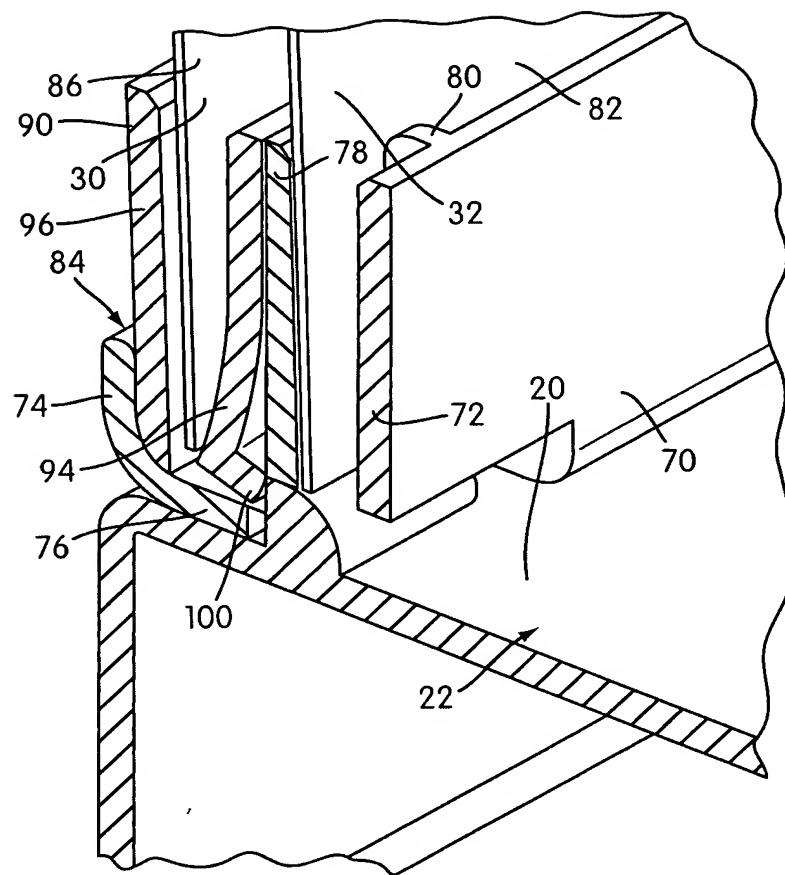


FIG. 13